

Electrostatic Discharged Protection Devices (ESD) Data Sheet

Description

Brightking's SET23AXXL02 series of transient voltage suppressor (TVS) are designed to protect components which are connected to data and transmission lines from voltage surges caused by electrostatic discharge (ESD), electrical fast transients (EFT) and lightning.

TVS diodes are characterized by their high surge capability, low operating and clamping voltages, and fast response time. This makes them ideal for use as board level protection of sensitive semiconductor components.

The low profile SOT-23 package allows flexibility in the design of crowded circuit boards.

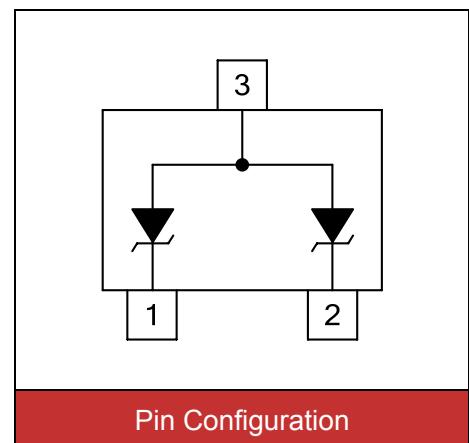


Contact : ±8kV
Air : ±15kV



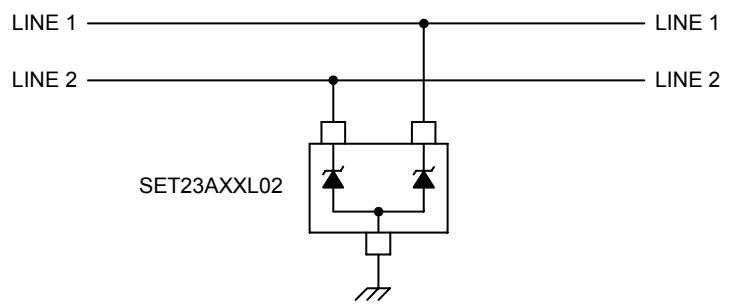
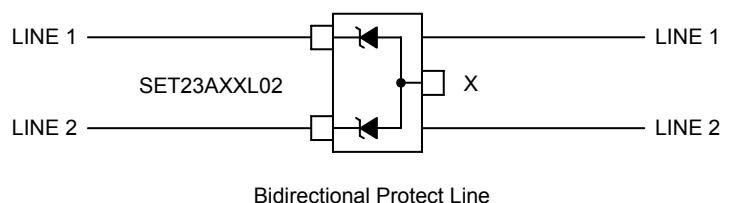
Features

- IEC61000-4-2 ESD 15KV Air, 8KV contact compliance
- SOT-23 surface mount package
- Protects one bidirectional line or two unidirectional lines
- Working voltage: 3.3V, 5V, 12V, 15V, 24V and 36V
- Low leakage current
- Low operating and clamping voltages
- Solid-state silicon avalanche technology
- Lead Free/RoHS compliant
- Solder reflow temperature: Pure Tin-Sn, 260~270°C
- Flammability rating UL 94V-0
- Meets MSL level 1, per J-STD-020



Applications

- Cellular handsets and accessories
- Personal digital assistants (PDA's)
- Portable instrumentation
- Set Top Box (STB)
- Servers, notebook, and desktop PC
- Wireless bus protection
- RS-232, RS-422, RS-423 protection



Maximum Ratings

Rating	Symbol	Value	Unit
ESD voltage (Contact discharge)	V_{ESD}	± 8	kV
ESD voltage (Air discharge)		± 15	
Storage & operating temperature range	T_{STG}, T_J	-55~+150	°C

Electrical Characteristics ($T_J=25^\circ C$)

SET23A03L02 (Marking: B 03C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	V_{RWM}				3.3	V
Reverse breakdown voltage	V_{BR}	$I_{BR}=1mA$	4			V
Reverse leakage current	I_R	$V_R=3.3V$ Each I/O pin			5	µA
Clamping voltage ($tp=8/20\mu s$)	V_C	$I_{PP}=1A$			7.5	V
Clamping voltage ($tp=8/20\mu s$)	V_C	$I_{PP}=10A$			15	V
Off state junction capacitance	C_J	0Vdc, $f=1MHz$ Between I/O pins and GND		200		pF

SET23A05L02 (Marking: B 05C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	V_{RWM}				5	V
Reverse breakdown voltage	V_{BR}	$I_{BR}=1mA$	6			V
Reverse leakage current	I_R	$V_R=5V$ Each I/O pin			5	µA
Clamping voltage ($tp=8/20\mu s$)	V_C	$I_{PP}=1A$			9.8	V
Clamping voltage ($tp=8/20\mu s$)	V_C	$I_{PP}=15A$			20	V
Off state junction capacitance	C_J	0Vdc, $f=1MHz$ Between I/O pins and GND		220		pF

Electrical Characteristics ($T_J=25^\circ\text{C}$)

SET23A12L02 (Marking: B 12C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	V_{RWM}				12	V
Reverse breakdown voltage	V_{BR}	$I_{BR}=1\text{mA}$	13.3			V
Reverse leakage current	I_R	$V_R=12\text{V}$ Each I/O pin			1	μA
Clamping voltage ($tp=8/20\mu\text{s}$)	V_C	$I_{PP}=1\text{A}$			19	V
Clamping voltage ($tp=8/20\mu\text{s}$)	V_C	$I_{PP}=10\text{A}$			25.9	V
Off state junction capacitance	C_J	0Vdc, $f=1\text{MHz}$ Between I/O pins and GND		100		pF

SET23A15L02 (Marking: B 15C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	V_{RWM}				15	V
Reverse breakdown voltage	V_{BR}	$I_{BR}=1\text{mA}$	16.7			V
Reverse leakage current	I_R	$V_R=15\text{V}$ Each I/O pin			1	μA
Clamping voltage ($tp=8/20\mu\text{s}$)	V_C	$I_{PP}=1\text{A}$			24	V
Clamping voltage ($tp=8/20\mu\text{s}$)	V_C	$I_{PP}=10\text{A}$			30	V
Off state junction capacitance	C_J	0Vdc, $f=1\text{MHz}$ Between I/O pins and GND		90		pF

SET23A24L02 (Marking: B 24C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	V_{RWM}				24	V
Reverse breakdown voltage	V_{BR}	$I_{BR}=1\text{mA}$	26.7			V
Reverse leakage current	I_R	$V_R=24\text{V}$ each I/O pin			1	μA
Clamping voltage ($tp=8/20\mu\text{s}$)	V_C	$I_{PP}=1\text{A}$			43	V
Clamping voltage ($tp=8/20\mu\text{s}$)	V_C	$I_{PP}=5\text{A}$			49	V
Off state junction capacitance	C_J	0Vdc, $f=1\text{MHz}$ Between I/O pins and GND		80		pF

Electrical Characteristics ($T_J=25^\circ\text{C}$)

SET23A36L02 (Marking: B 36C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	V_{RWM}				36	V
Reverse breakdown voltage	V_{BR}	$I_{BR}=1\text{mA}$	40			V
Reverse leakage current	I_R	$V_R=36\text{V}$ each I/O pin			1	μA
Clamping voltage ($t_p=8/20\mu\text{s}$)	V_C	$I_{PP}=1\text{A}$			51	V
Clamping voltage ($t_p=8/20\mu\text{s}$)	V_C	$I_{PP}=5\text{A}$			76.8	V
Off state junction capacitance	C_J	0Vdc, $f=1\text{MHz}$ Between I/O pins and GND		70		pF

Typical Characteristics Curves

Figure 1. Power Derating Curve

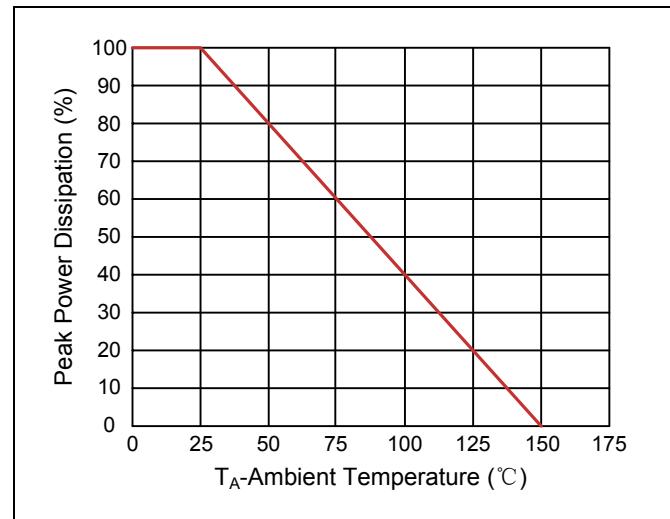


Figure 2. Pulse Waveforms

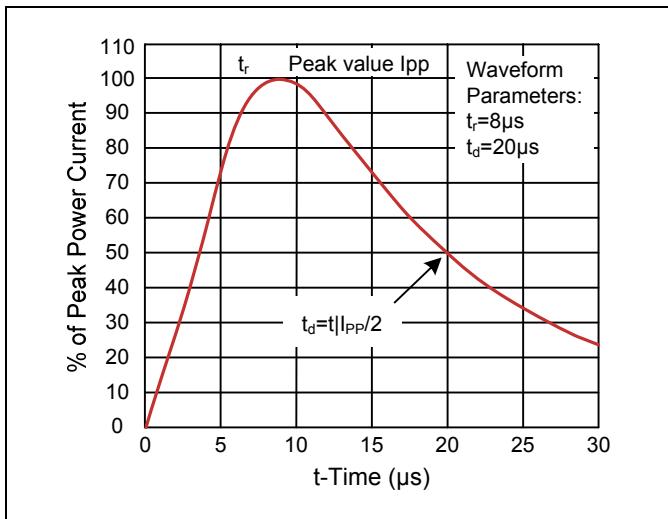


Figure 3. Forward Voltage vs. Forward Current

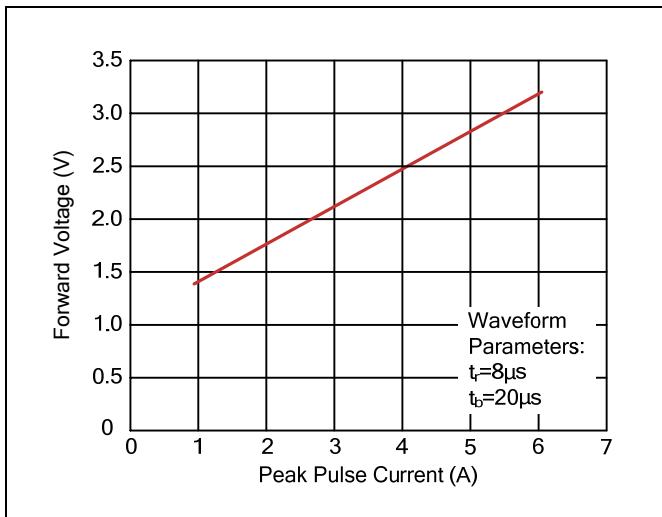
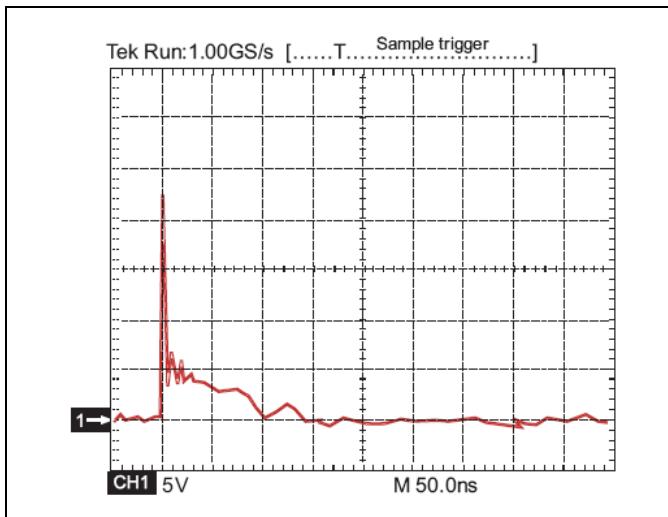
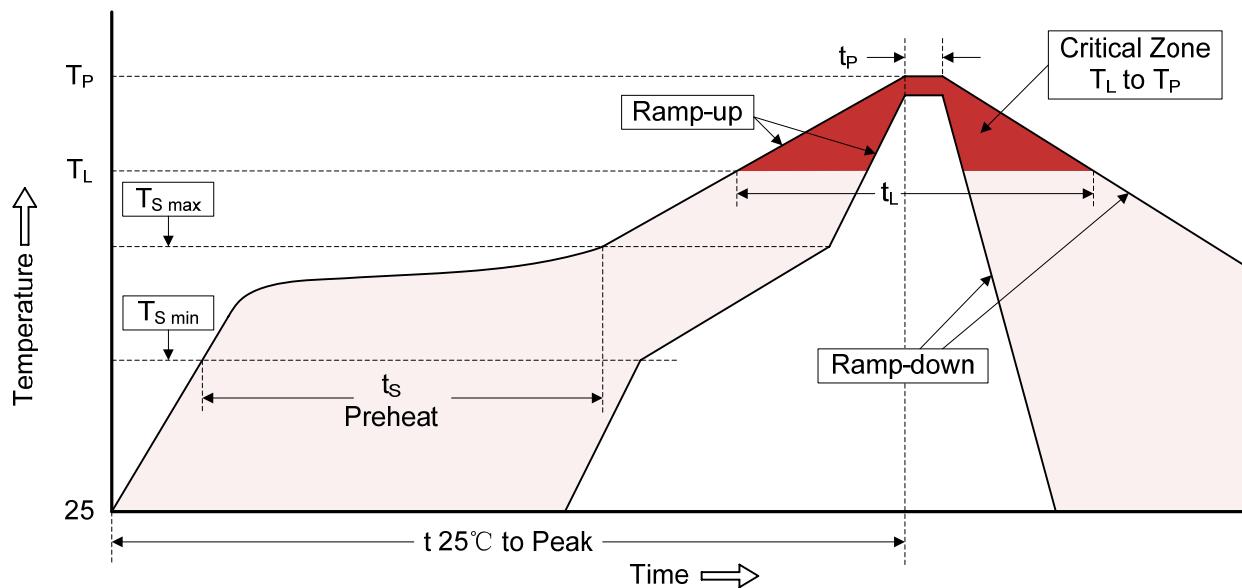


Figure 4. ESD Clamping(8kV Contact IEC61000-4-2)



Recommended Soldering Conditions

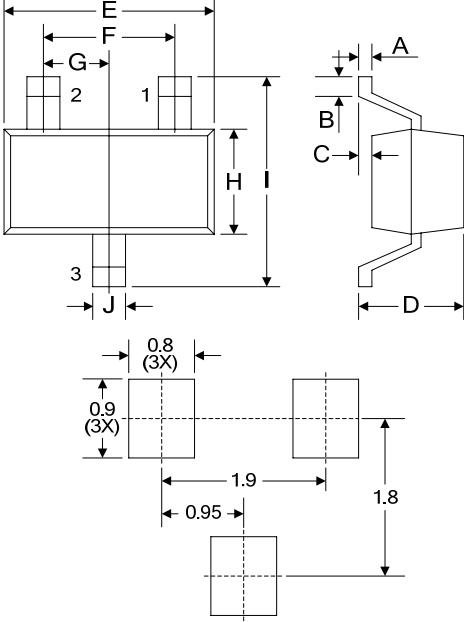
Reflow Soldering



Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T_L to T_P)	3°C/second max.
Preheat	
- Temperature Min ($T_{S\ min}$)	150°C
- Temperature Max ($T_{S\ max}$)	200°C
- Time (min to max) (t_s)	60-180 seconds
$T_{S\ max}$ to T_L	
- Ramp-up Rate	3°C/second max.
Time maintained above:	
- Temperature (T_L)	217°C
- Time (t_L)	60-150 seconds
Peak Temperature (T_P)	260°C
Time within 5°C of actual Peak Temperature (t_P)	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

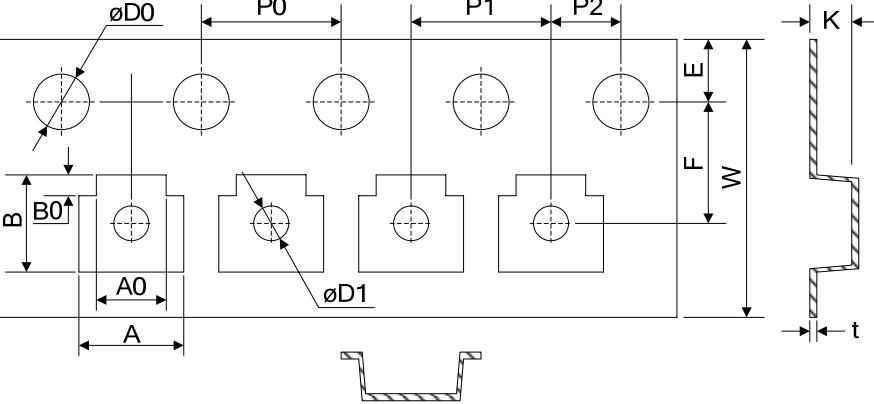
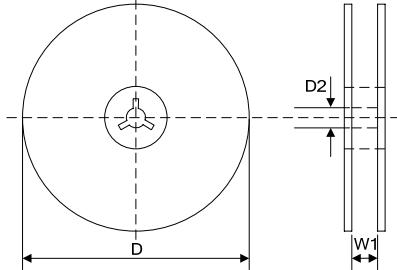
Dimensions (SOT-23)



The technical drawing shows the physical dimensions of the SOT-23 package. It includes top and side views with labeled dimensions A through J. Below the main drawing is a detailed 'Recommended Soldering Pad Layout' showing the internal structure of the package with pads labeled 1, 2, and 3.

Symbol	Dimension			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.08	0.18	0.003	0.007
B	0.15	-	0.006	-
C	-	0.13	-	0.005
D	0.89	1.09	0.035	0.043
E	2.80	3.05	0.110	0.120
F	1.90		0.075	
G	0.95		0.037	
H	1.19	1.40	0.047	0.055
I	2.10	2.49	0.083	0.098
J	0.35	0.50	0.014	0.020

Packaging

Tape	 <p>The diagram shows the layout of the tape for the SOT-23 packages. It includes dimensions for the total width (W), pitch between packages (P0, P1, P2), lead diameter (D0, D1), lead thickness (E, F), lead height (A), lead gap (A0), lead width (B), lead gap (B0), lead thickness (t), and lead height (K).</p>	<table border="1"> <thead> <tr> <th>Symbol</th> <th>Dimension (mm)</th> </tr> </thead> <tbody> <tr> <td>W</td> <td>8.00±0.30</td> </tr> <tr> <td>P0</td> <td>4.00±0.10</td> </tr> <tr> <td>P1</td> <td>4.00±0.10</td> </tr> <tr> <td>P2</td> <td>2.00±0.10</td> </tr> <tr> <td>D0</td> <td>Φ1.55±0.10</td> </tr> <tr> <td>D1</td> <td>Φ1.00±0.05</td> </tr> <tr> <td>E</td> <td>1.75±0.10</td> </tr> <tr> <td>F</td> <td>3.50±0.10</td> </tr> <tr> <td>A</td> <td>3.10±0.10</td> </tr> <tr> <td>A0</td> <td>2.10±0.10</td> </tr> <tr> <td>B</td> <td>2.75±0.10</td> </tr> <tr> <td>B0</td> <td>0.65±0.10</td> </tr> <tr> <td>K</td> <td>1.10±0.10</td> </tr> <tr> <td>t</td> <td>0.20±0.05</td> </tr> </tbody> </table>	Symbol	Dimension (mm)	W	8.00±0.30	P0	4.00±0.10	P1	4.00±0.10	P2	2.00±0.10	D0	Φ1.55±0.10	D1	Φ1.00±0.05	E	1.75±0.10	F	3.50±0.10	A	3.10±0.10	A0	2.10±0.10	B	2.75±0.10	B0	0.65±0.10	K	1.10±0.10	t	0.20±0.05
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Reel	 <p>The diagram shows the layout of the reel for the SOT-23 packages. It includes dimensions for the outer diameter (D), inner diameter (D2), and reel height (W1).</p>	<table border="1"> <tbody> <tr> <td>D</td> <td>Φ178.0±2.0</td> </tr> <tr> <td>D2</td> <td>Φ13.0</td> </tr> <tr> <td>W1</td> <td>9.5</td> </tr> <tr> <td>Quantity:</td> <td>3000PCS</td> </tr> </tbody> </table>	D	Φ178.0±2.0	D2	Φ13.0	W1	9.5	Quantity:	3000PCS																						
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